

## **VEHICULAR 2012**

### **Committee**

#### **VEHICULAR Advisory Committee**

Eugen Borcoci, University ‘Politehnica’ of Bucharest, Romania  
Pascal Lorenz, University of Haute Alsace, France  
Petre Dini, Concordia University, Canada / China Space Agency Center, China

#### **VEHICULAR Technical Program Committee**

Aydin Akan, Istanbul University, Turkey  
Waleed Alasmari, University of Toronto, Canada  
Andrea Baiocchi, SAPIENZA University of Rome, Italy  
Irina Balan, Ghent University - IBBT, Belgium  
Monique Becker, Institut Mines Telecom, France  
Luis Bernardo, Universidade Nova of Lisboa, Portugal  
Yuanguo Bi, Northeastern University, China  
Pascal Bodin, Orange Labs, France  
Mélanie Bouroche, Trinity College Dublin, Ireland  
Robert Budde, TU Dortmund University, Germany  
Chiara Buratti, DEIS, University of Bologna, Italy  
Maria Calderon, University Carlos III of Madrid, Spain  
Jean Pierre Cances, University of Limoges, France  
Hongyang Chen, Fujitsu Labs. Ltd, Japan  
Lien-Wu Chen, Feng Chia University - Taichung, Taiwan  
Chien-Liang Chen, Aletheia University - Taipei, Taiwan  
Ray-Guang Cheng, National Taiwan University of Science and Technology - Taipei, Taiwan,  
R.O.C.  
Yonggang Chi, Harbin Institute of Technology, China  
Dong Ho Cho, Korea Advanced Institute of Science and Technology - Daejeon, Republic of Korea  
Juan Antonio Cordero Fuertes, INRIA, France  
Carl James Debono, University of Malta - Msida, Malta  
Trung Q. Duong, Blekinge Institute of Technology, Sweden  
Weiwei Fang (方维维), Beijing Jiaotong University (BJTU) - Beijing, China  
Michel Ferreira, University of Porto and Instituto de Telecomunicações, Portugal  
Alois Ferscha, Institut für Pervasive Computing, Johannes Kepler Universität Linz, Austria  
Malgorzata Gajewska, Gdansk University of Technology, Poland  
Slawomir Gajewski, Gdansk University of Technology, Poland  
Hassan Ghasemzadeh, University of California - Los Angeles, USA  
Athanasios Gkelias, Imperial College London, UK

Javier Gozalvez, UWICORE Laboratory, University Miguel Hernandez of Elche, Spain  
An He, Qualcomm, USA  
Jianhua He, Swansea University, UK  
Khelifa Hettak, Industry Canada / Communications Research Centre - Nepean, Canada  
Daesik Hong, Yonsei University - Seoul, Korea  
Daniel Jiang, Mercedes-Benz Research & Development North America, USA  
Georgios Karagiannis, University of Twente, The Netherlands  
Gunes Karabulut Kurt, Istanbul Technical University - Istanbul, Turkey  
John Lee, Telcordia Technologies Inc., USA  
Jungwoo Lee, Seoul National University, Korea  
Jingli Li, Emerson Electric Co. - Louisville, USA  
XiangYang Li, Illinois Institute of Technology - Chicago, USA  
Qilian Liang, University of Texas at Arlington, USA  
Kuang-Hao Lin, National Chin-Yi University of Technology, Taiwan  
Thomas Little, Boston University, USA  
Rongxing Lu, University of Waterloo, Canada  
Johan Lukkien, Eindhoven University of Technology, The Netherlands  
Barbara M. Masini, CNR - IEIIT, University of Bologna, Italy  
Abolfazl Mehbodniya, Tohoku University, Japan  
Ingrid Moerman, Ghent University - IBBT, Belgium  
Hidekazu Murata, Kyoto University, Japan  
Stefan Nowak, TU Dortmund University, Germany  
Shumao Ou, Oxford Brookes University, UK  
Mohammad Patwary, Staffordshire University, UK  
Matthias Uwe Pätzold, University of Agder - Grimstad, Norway  
Adrian Popescu, Blekinge Institute of Technology - Karlskrona, Sweden  
Ravi Prakash, University of Texas at Dallas, USA  
M. Elena Renda, IIT - CNR - Pisa, Italy  
Tapani Ristaniemi, University of Jyväskylä, Finland  
Marco Roccetti, University of Bologna, Italy  
Won-Yong Shin, Harvard University, USA  
Marcin Sokól, Gdańsk University of Technology, Poland  
Hwangjun Song, POSTECH (Pohang Univ of Science and Technology) - Pohang, Korea  
Kemal Ertugrul Tepe, University of Windsor, Canada  
Carlo Vallati, University of Pisa, Italy  
Fabrice Valois, INRIA SWING / CITI, INSA-Lyon, France  
Necmi Taspinar, Erciyes University - Kayseri, Turkey  
Olav Tirkkonen, Aalto University, Finland  
Theodoros A. Tsiftsis, Technological Educational Institute of Lamia, Greece  
Wenjing Wang, Blue Coat Systems, Inc., USA  
Yue Wang, Toshiba Research Europe Ltd. - Bristol, UK  
You-Chiun Wang, National Sun Yat-Sen University, Taiwan  
André Weimerskirch, escrypt Inc., USA  
Chih-Yu Wen, National Chung Hsing University - Taichung, Taiwan

Weidong Xiang, University of Michigan - Dearborn, USA  
Zheng Yan, Aalto University - Espoo, Finland / Xidian University Xi'an, China  
Wei Yuan, Huazhong University of Science and Technology - Wuhan, China  
Peng Zhang, Xi`An University of Posts and Telecommunications (XUPT), China  
Wensheng Zhang, Iowa State University, USA  
Zhangbing Zhou, China University of Geosciences - Beijing, China & TELECOM SudParis, France  
Haojin Zhu, Shanghai Jiao Tong University, China  
Yanmin Zhu, Shanghai Jiao Tong University, China